SWITCHMODE II Series NPN Silicon Power Transistors

The BUV48/BUV48A transistors are designed for high–voltage, high–speed, power switching in inductive circuits where fall time is critical. They are particularly suited for line–operated switchmode applications such as:

- Switching Regulators
- Inverters
- · Solenoid and Relay Drivers
- Motor Controls
- Deflection Circuits

Fast Turn-Off Times

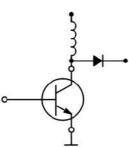
60 ns Inductive Fall Time — 25°C (Typ) 120 ns Inductive Crossover Time — 25°C (Typ)

Operating Temperature Range -65 to +175°C

100°C Performance Specified for:

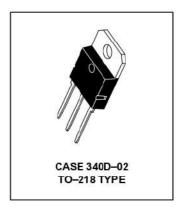
Reverse–Biased SOA with Inductive Loads Switching Times with Inductive Loads Saturation Voltage

Leakage Currents (125°C)



BUV48 BUV48A

15 AMPERES
NPN SILICON
POWER TRANSISTORS
400 AND 450 VOLTS
V(BR)CEO
850-1000 VOLTS
V(BR)CEX
150 WATTS



MAXIMUM RATINGS

Rating	Symbol	BUV48	BUV48A	Unit
Collector–Emitter Voltage	V _{CEO(sus)}	400	450	Vdc
Collector–Emitter Voltage (V _{BE} = -1.5 V)	V _{CEX}	V _{CEX} 850		Vdc
Emitter Base Voltage	V _{EB}	7		Vdc
Collector Current — Continuous — Peak (1) — Overload	IC ICM IOI	I _{CM} 30		Adc
Base Current — Continuous — Peak (1)	I _B	5 20		Adc
Total Power Dissipation — T_C = 25°C — T_C = 100°C Derate above 25°C	PD		50 75 1	Watts W/°C
Operating and Storage Junction Temperature Range	T _J , T _{Stg}	−65 t	o + 175	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	R ø JC	° 1	°C/W
Maximum Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	ΤĹ	275	°C

(1) Pulse Test: Pulse Width = 5 ms, Duty Cycle ≤ 10%.

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BUV48 BUV48A

$\textbf{ELECTRICAL CHARACTERISTICS} \ (T_C = 25^{\circ}C \ unless \ otherwise \ noted)$

	Characteristic		Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTIC	CS (1)					-9/-		
Collector–Emitter Sust (I _C = 200 mA, I _B = 0		ole 1) N N/48 DU V40	BUV48A	VCEO(sus)	400 450	1		Vdc
Collector Cutoff Currer (V _{CEX} = Rated Valu (V _{CEX} = Rated Valu	ie, V _{BE(off)} = 1.5 \)	ICEX	3 T	1 [0.2 2	mAdc
Collector Cutoff Currer (VCE = Rated VCE)			T _C = 25°C T _C = 125°C	ICER	:— :—	1.1	0.5 3	mAdc
Emitter Cutoff Current (VEB = 5 Vdc, IC = 0				I _{EBO}	(% <u>—15</u>	<u> </u>	0.1	mAdc
Emitter-Base Breakdo (I _E = 50 mA - I _C = 0				V _{(BR)EBO}	7	-	57 -1 87	Vdc
SECOND BREAKDOW	N					-		
Second Breakdown Co	ollector Current wit	h Base Forward	Biased	I _{S/b}		See Figure 12	2	
Clamped Inductive SC	A with Base Reve	rse Biased		RBSOA	See Figure 13			
ON CHARACTERISTIC	S (1)					<u></u>		
DC Current Gain (I _C = 10 Adc, V _{CE} = (I _C = 8 Adc, V _{CE} =	5 Vdc)		BUV48 BUV48A	hFE	8		25—18 25—28	
Collector-Emitter Satur (I _C = 10 Adc, I _B = 2 (I _C = 15 Adc, I _B = 3 (I _C = 10 Adc, I _B = 2 (I _C = 8 Adc, I _B = 1.6 (I _C = 12 Adc, I _B = 2 (I _C = 8 Adc, I _B = 1.6	Adc) Adc) Adc, T _C = 100°C) Adc) 4 Adc)		BUV48 BUV48A	VCE(sat)		[] [] []	1.5 5 2 1.5 5 2	Vdc
Base–Emitter Saturation ($I_C = 10$ Adc, $I_B = 2$ ($I_C = 10$ Adc, $I_B = 2$ ($I_C = 8$ Adc, $I_B = 1.6$ ($I_C = 8$ Adc, $I_B = 1.6$	Adc) Adc, T _C = 100°C) Adc)		BUV48 BUV48A	V _{BE} (sat)	20-3 20-3 20-3 20-3	1111	1.6 1.6 1.6 1.6	Vdc
DYNAMIC CHARACTE	RISTICS							
Output Capacitance (V _{CB} = 10 Vdc, I _E =	0, f _{test} = 1 MHz)			C _{ob}		9 -3	350	pF
SWITCHING CHARACT Resistive Load (Table 1								
Delay Time		210	121110000000	t _d	(s -11	0.1	0.2	µ s
	$I_C = 10 \text{ A}, I_B = 2 \text{ A}$ $I_C = 8 \text{ A}, I_B = 1.6$		BUV48 BUV48A	t _r	35=01	0.4	0.7	1
Storage Time	Duty Cycle ≤ 2%,	$V_{BF(off)} = 5 V$	201.01	t _s	Ø -7 3	1.3	2	1
Fall Time	T _p = 30 µ s, V _{CC} =	: 300 V		t _f	% <u>===</u>	0.2	0.4	1
nductive Load, Clamp	ed (Table 1)							
Storage Time	and the second second second		AL OPERESTAL	t _{sv}	3	1.3	80 - 16	μs
	I _C = 10 A	BUV48	(T _C = 25°C)	tri	16 	0.06	==	1
Storage Time	$I_{B1} = 2 A$			t _{sv}	S I - 18	1.5	2.5	1
Crossovor Timo	I _C = 8 A	BUV48A	(T _C = 100°C)	t _c	11	0.3	0.6	1
Fall Time	$I_{B1} = 1.6 A$			ti	78-01	0.17	0.35	1
rui IIIIo				1 41	(S-70)	V. 17	0.00	

⁽¹⁾ Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2%. Vd = 300 V, VBE(off) = 5 V, Lc = 180 μ H

DC CHARACTERISTICS

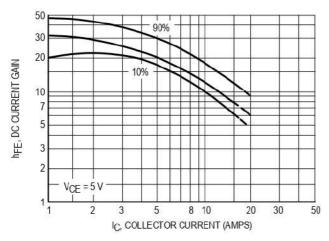


Figure 1. DC Current Gain

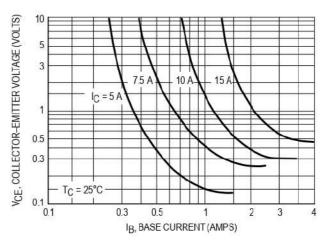


Figure 2. Collector Saturation Region

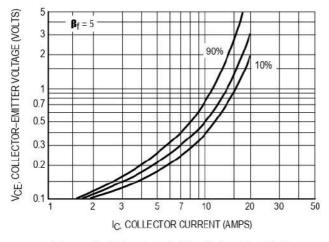


Figure 3. Collector-Emitter Saturation Voltage

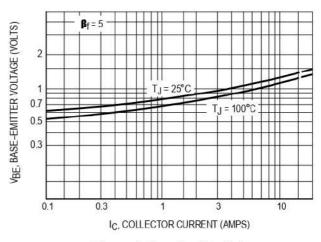


Figure 4. Base-Emitter Voltage

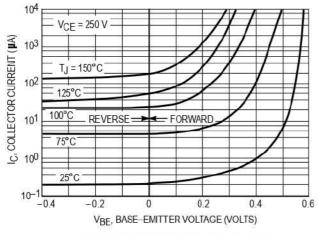


Figure 5. Collector Cutoff Region

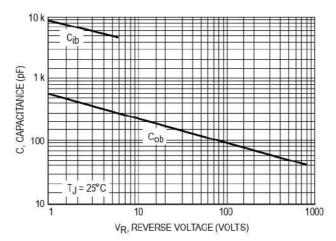
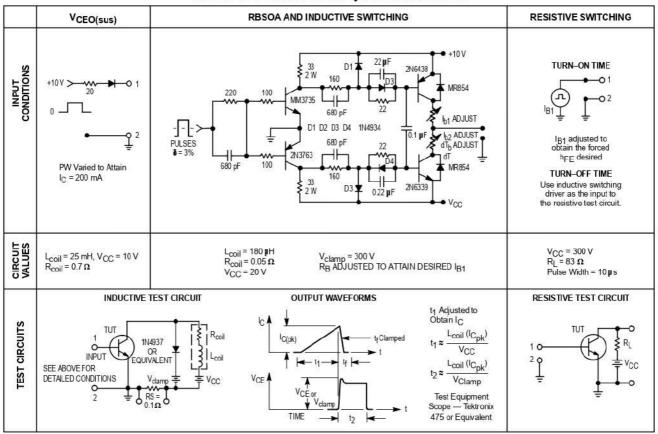


Figure 6. Capacitance

BUV48 BUV48A

Table 1. Test Conditions for Dynamic Performance



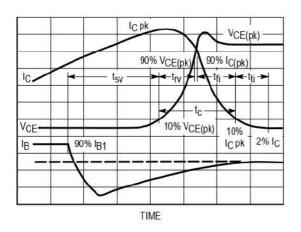


Figure 7. Inductive Switching Measurements

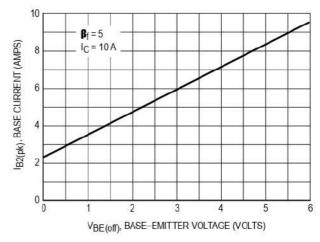


Figure 8. Peak-Reverse Current

SWITCHING TIMES NOTE

In resistive switching circuits, rise, fall, and storage times have been defined and apply to both current and voltage waveforms since they are in phase. However, for inductive loads which are common to SWITCHMODE power supplies and hammer drivers, current and voltage waveforms are not in phase. Therefore, separate measurements must be made on each waveform to determine the total switching time. For this reason, the following new terms have been defined.

t_{SV} = Voltage Storage Time, 90% I_{B1} to 10% V_{clamp}

t_{rv} = Voltage Rise Time, 10-90% V_{clamp}

tfi = Current Fall Time, 90-10% IC

tti = Current Tail, 10-2% IC

t_c = Crossover Time, 10% V_{clamp} to 10% I_C

An enlarged portion of the inductive switching waveforms is

shown in Figure 7 to aid in the visual identity of these terms.

For the designer, there is minimal switching loss during storage time and the predominant switching power losses occur during the crossover interval and can be obtained using the standard equation from AN-222:

$$PSWT = 1/2 VCClC(t_C) f$$

In general, t_{rV} + $t_{fi} \simeq t_{C}$. However, at lower test currents this relationship may not be valid.

As is common with most switching transistors, resistive switching is specified at 25 $^{\circ}$ C and has become a benchmark for designers. However, for designers of high frequency converter circuits, the user oriented specifications which make this a "SWITCHMODE" transistor are the inductive switching speeds (t_C and t_{SV}) which are guaranteed at 100 $^{\circ}$ C.

INDUCTIVE SWITCHING

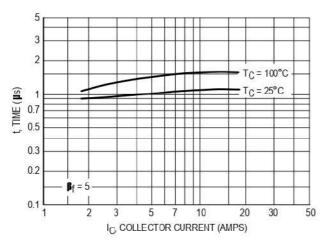


Figure 9. Storage Time, tsv

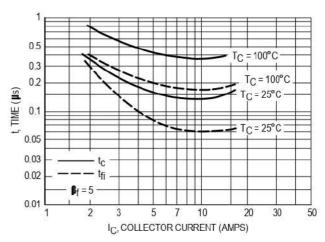


Figure 10. Crossover and Fall Times

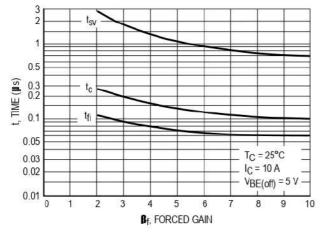


Figure 11a. Turn-Off Times versus Forced Gain

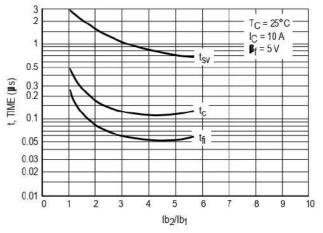


Figure 11b. Turn-Off Times versus lb2/lb1

BUV48 BUV48A

The Safe Operating Area figures shown in Figures 12 and 13 are specified for these devices under the test conditions shown.

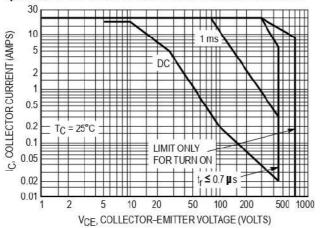


Figure 12. Forward Bias Safe Operating Area

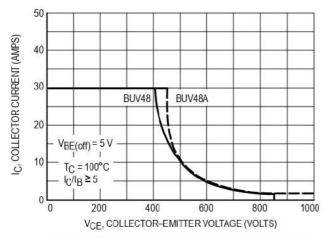


Figure 13. Reverse Bias Safe Operating Area

SAFE OPERATING AREA INFORMATION

FORWARD BIAS

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate I_C – V_{CE} limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 12 is based on $T_C = 25\,^{\circ}C$; $T_{J(pk)}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when $T_C \leq 25\,^{\circ}C$. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown on Figure 12 may be found at any case temperature by using the appropriate curve on Figure 14.

 $T_{J(pk)}$ may be calculated from the data in Figure 11. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

REVERSE BIAS

For inductive loads, high voltage and high current must be sustained simultaneously during turn–off, in most cases, with the base to emitter junction reverse biased. Under these conditions the collector voltage must be held to a safe level at or below a specific value of collector current. This can be accomplished by several means such as active clamping, RC snubbing, load line shaping, etc. The safe level for these devices is specified as Reverse Bias Safe Operating Area and represents the voltage current conditions during reverse biased turn–off. This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode. Figure 13 gives RBSOA characteristics.

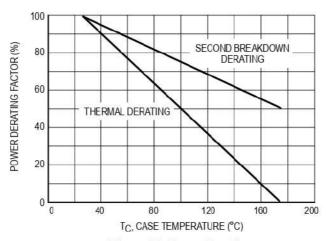


Figure 14. Power Derating

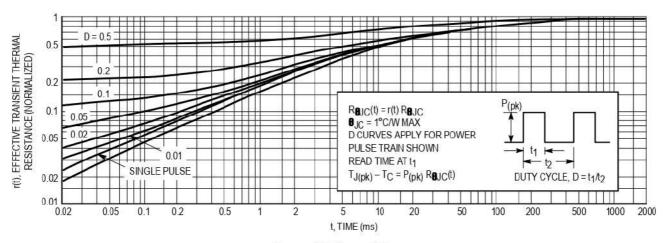


Figure 15. Thermal Response

OVERLOAD CHARACTERISTICS

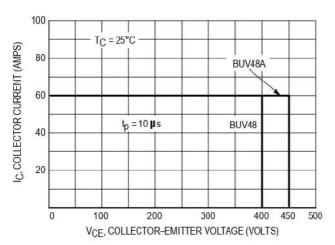


Figure 16. Rated Overload Safe Operating Area (OLSOA)

OLSOA

OLSOA applies when maximum collector current is limited and known. A good example is a circuit where an inductor is inserted between the transistor and the bus, which limits the rate of rise of collector current to a known value. If the transistor is then turned off within a specified amount of time, the magnitude of collector current is also known.

Maximum allowable collector—emitter voltage versus collector current is plotted for several pulse widths. (Pulse width is defined as the time lag between the fault condition and the removal of base drive.) Storage time of the transistor has been factored into the curve. Therefore, with bus voltage and maximum collector current known, Figure 16 defines the maximum time which can be allowed for fault detection and shutdown of base drive.

OLSOA is measured in a common–base circuit (Figure 18) which allows precise definition of collector–emitter voltage and collector current. This is the same circuit that is used to measure forward–bias safe operating area.

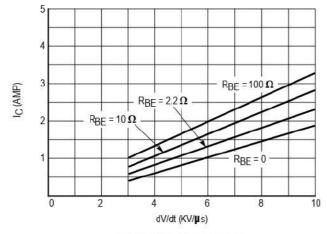


Figure 17. $I_C = f(dV/dt)$

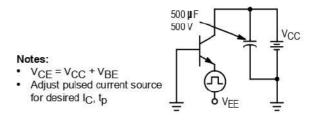
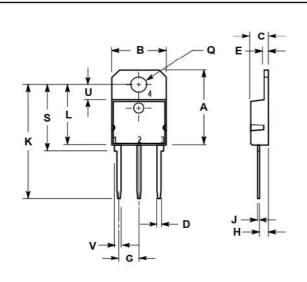


Figure 18. Overload SOA Test Circuit

PACKAGE DIMENSIONS



CASE 340D-02 **TO-218 TYPE ISSUE B**

- 1. DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER.

	MILLN	ETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
A	-	20.35		0.801	
В	14.70	15.20	0.579	0.598	
C	4.70	4.90	0.185	0.193	
D	1.10	1.30	0.043	0.051	
E	1.17	1.37	0.046	0.054	
G	5.40	5.55	0.213	0.219	
Н	2.00	3.00	0.079	0.118	
J	0.50	0.78	0.020	0.031	
K	31.00 REF		1.220 REF		
L	1 420	16.20		0.638	
Q	4.00	4.10	0.158	0.161	
S	17.80	18.20	0.701	0.717	
U	4.00 REF		0.157	REF	
٧	1.75 REF		0.069		

STYLE 1: PIN 1. BASE

COLLECTOR EMITTER

4. COLLECTOR

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BUV48/D